

Automotive N-Channel 150 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY	
V_{DS} (V)	150
$R_{DS(on)}$ (Ω) at $V_{GS} = 10$ V	0.0019
I_D (A)	85
Configuration	Single

FEATURES

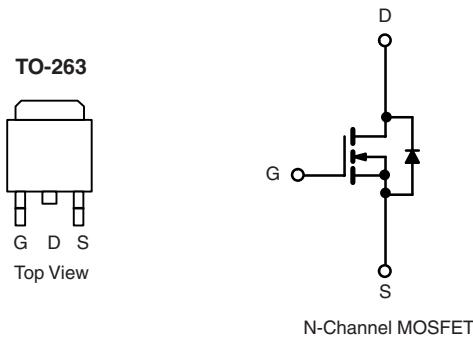
- Halogen-free
- TrenchFET® Power MOSFET
- Package with Low Thermal Resistance



RoHS
COMPLIANT

AEC-Q101 RELIABILITY

- Passed all AEC-Q101 Reliability Testing
- Characterization Ongoing



ORDERING INFORMATION	
Package	TO-263
Lead (Pb)-free and Halogen-free	SQM85N15-19-GE3

ABSOLUTE MAXIMUM RATINGS $T_C = 25$ °C, unless otherwise noted				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V_{DS}	150	V
Gate-Source Voltage		V_{GS}	± 20	
Continuous Drain Current ^a	$T_C = 25$ °C	I_D	85	A
	$T_C = 125$ °C		50	
Continuous Source Current (Diode Conduction) ^a		I_S	85	
Pulsed Drain Current ^b		I_{DM}	180	
Single Pulse Avalanche Energy	$L = 0.1$ mH	E_{AS}	125	mJ
Single Pulse Avalanche Current		I_{AS}	70	
Maximum Power Dissipation ^b	$T_C = 25$ °C	P_D	375	W
	$T_A = 25$ °C		3.75	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to + 175	°C

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount ^c	R_{thJA}	40	°C/W
Junction-to-Case (Drain)		R_{thJC}	0.4	

Notes

- Package limited.
- Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.
- When mounted on 1" square PCB (FR-4 material).

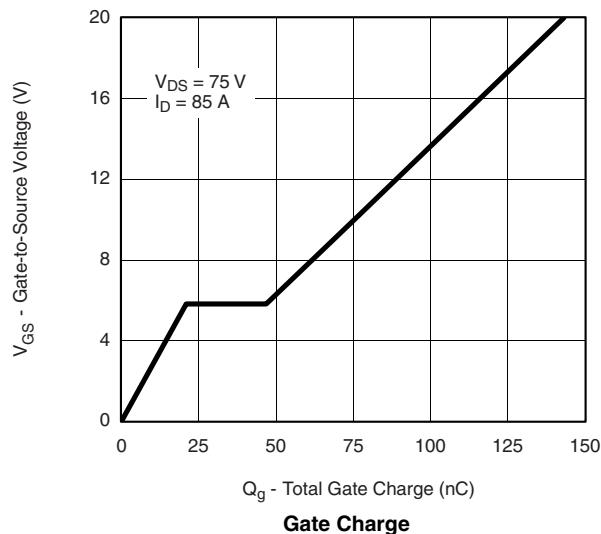
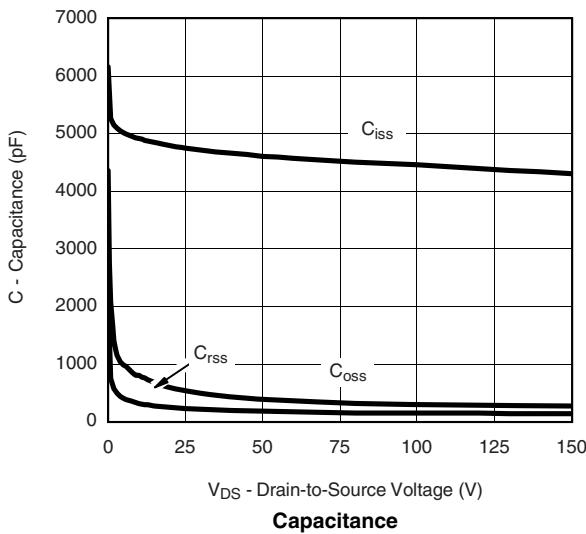
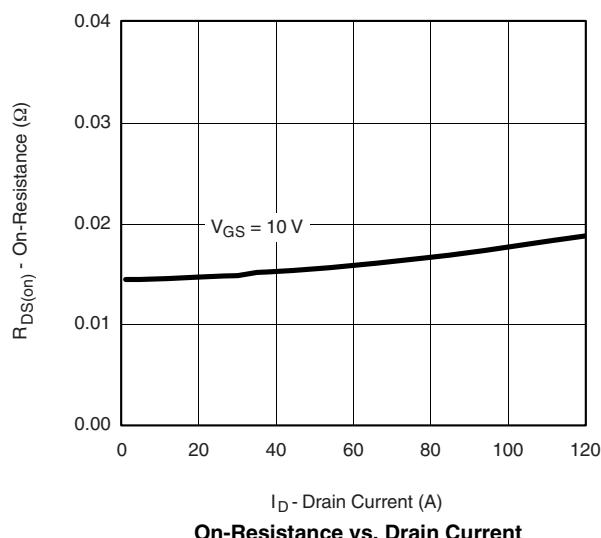
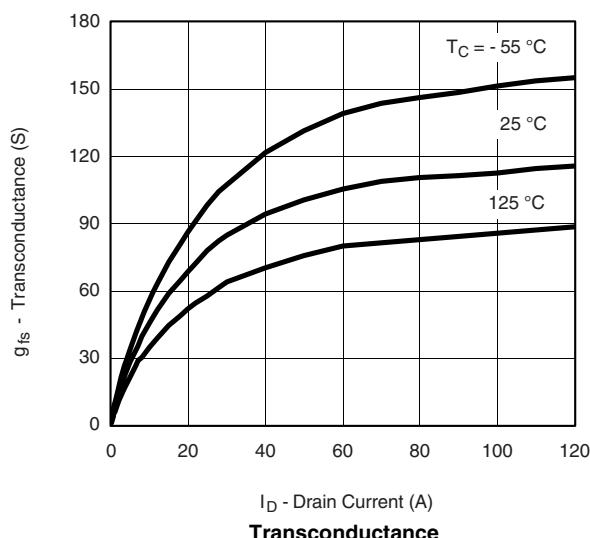
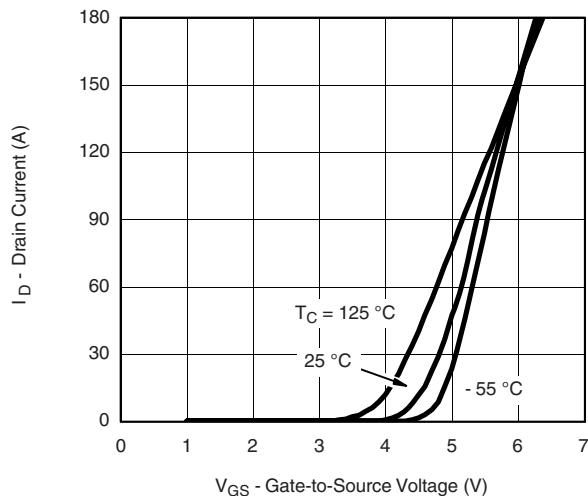
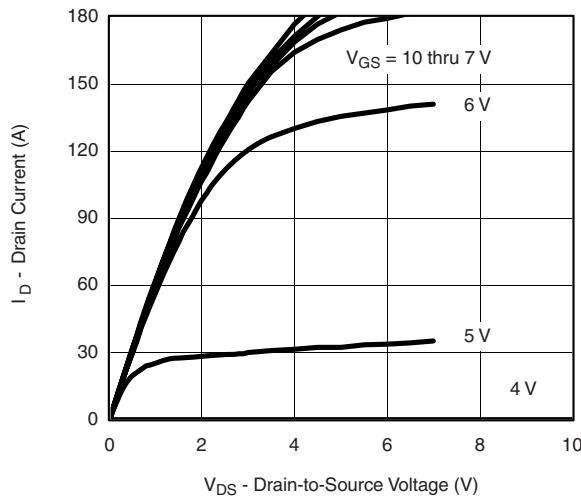
SPECIFICATIONS $T_C = 25^\circ\text{C}$, unless otherwise noted

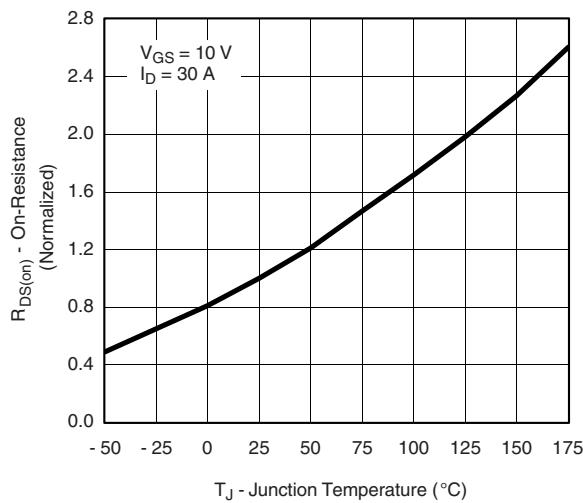
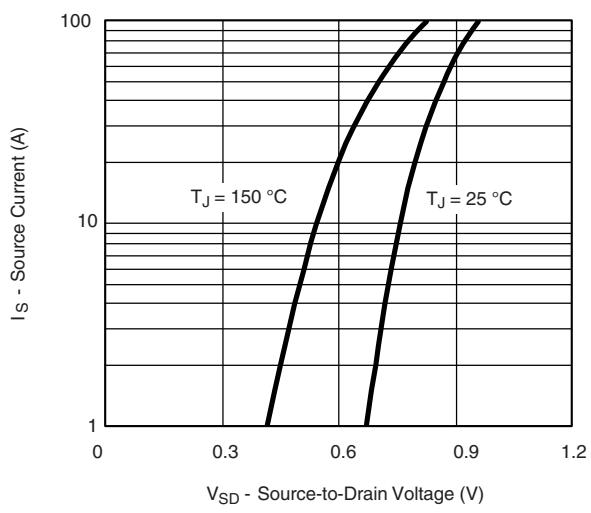
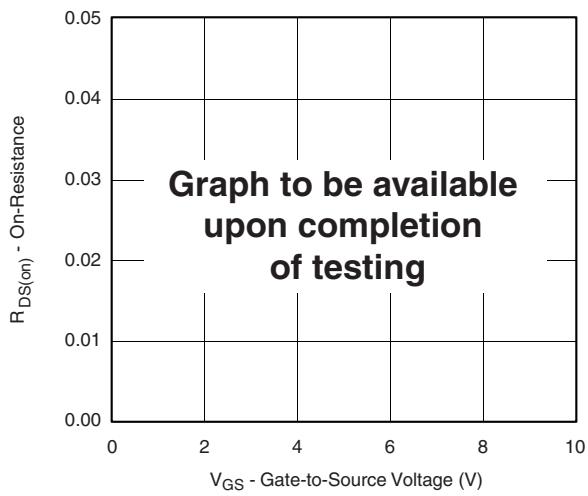
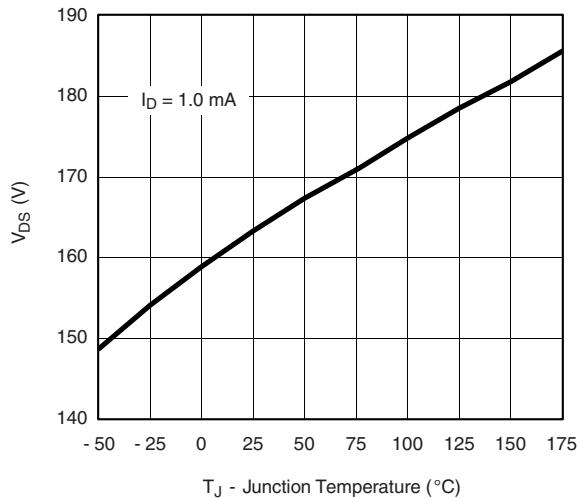
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}$	$I_D = 250 \mu\text{A}$	150	-	-	V	
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}$	$I_D = 250 \mu\text{A}$	2.0	-	4.0		
Gate-Source Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}$	$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{GS} = 0 \text{ V}$	$V_{DS} = 150 \text{ V}$	-	-	1.0	μA	
		$V_{GS} = 0 \text{ V}$	$V_{DS} = 150 \text{ V}, T_J = 125^\circ\text{C}$	-	-	50		
		$V_{GS} = 0 \text{ V}$	$V_{DS} = 150 \text{ V}, T_J = 175^\circ\text{C}$	-	-	250		
On-State Drain Current ^a	$I_{D(\text{on})}$	$V_{GS} = 10 \text{ V}$	$V_{DS} \geq 5 \text{ V}$	120	-	-	A	
Drain-Source On-State Resistance ^a	$R_{DS(\text{on})}$	$V_{GS} = 10 \text{ V}$	$I_D = 30 \text{ A}$	-	0.015	0.019	Ω	
		$V_{GS} = 10 \text{ V}$	$I_D = 30 \text{ A}, T_J = 125^\circ\text{C}$	-	-	0.038		
		$V_{GS} = 10 \text{ V}$	$I_D = 30 \text{ A}, T_J = 175^\circ\text{C}$	-	-	0.050		
Forward Transconductance ^a	g_{fs}	$V_{DS} = 15 \text{ V}, I_D = 30 \text{ A}$		25	-	-	S	
Dynamic^b								
Input Capacitance	C_{iss}	$V_{GS} = 0 \text{ V}$	$V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	-	4750	-	pF	
Output Capacitance	C_{oss}			-	530	-		
Reverse Transfer Capacitance	C_{rss}			-	220	-		
Total Gate Charge ^c	Q_g	$V_{GS} = 10 \text{ V}$	$V_{DS} = 75 \text{ V}, I_D = 85 \text{ A}$	-	76	-	nC	
Gate-Source Charge ^c	Q_{gs}			-	21	-		
Gate-Drain Charge ^c	Q_{gd}			-	26	-		
Turn-On Delay Time ^c	$t_{d(\text{on})}$	$V_{DD} = 75 \text{ V}, R_L = 0.9 \Omega$ $I_D \geq 85 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$	$V_{DS} = 75 \text{ V}, I_D = 85 \text{ A}$	-	22	-	ns	
Rise Time ^c	t_r			-	170	-		
Turn-Off Delay Time ^c	$t_{d(\text{off})}$			-	40	-		
Fall Time ^c	t_f			-	170	-		
Source-Drain Diode Ratings and Characteristics $T_C = 25^\circ\text{C}^b$								
Pulsed Current ^a	I_{SM}			-	-	180	A	
Forward Voltage	V_{SD}	$I_F = 85 \text{ A}, V_{GS} = 0 \text{ V}$		-	1.0	1.5	V	
Reverse Recovery Time	t_{rr}	$I_F = 50 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$		-	130	-	ns	
Peak Reverse Recovery Current	$I_{RM(\text{REC})}$			-	8.0	-	A	
Reverse Recovery Charge	Q_{rr}			-	0.52	-	μC	

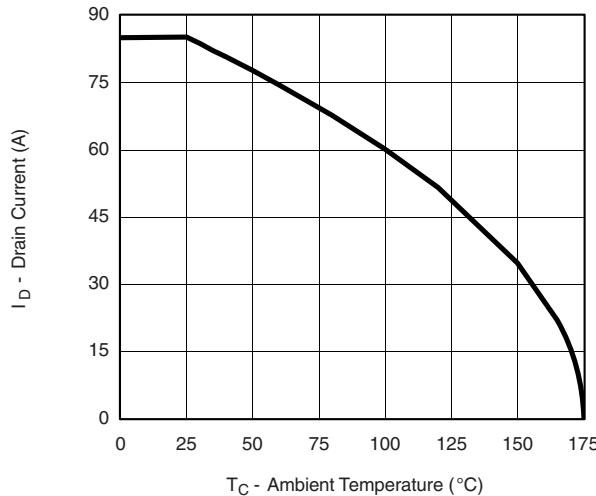
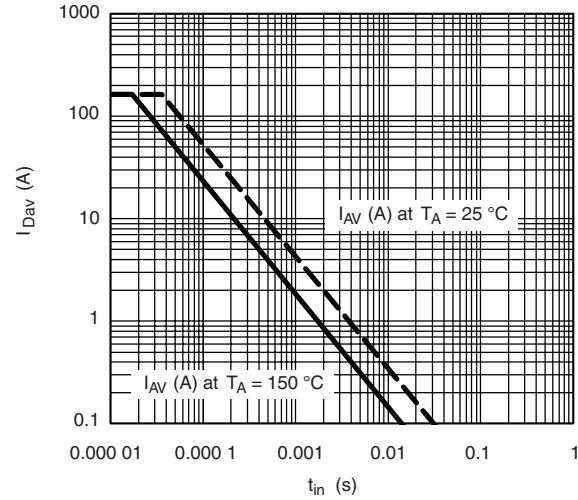
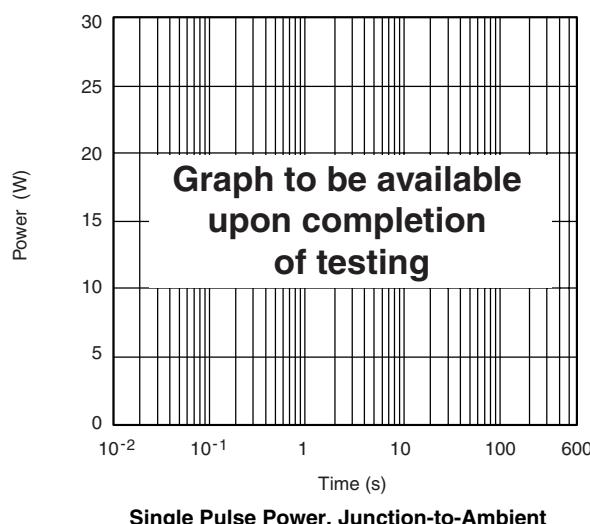
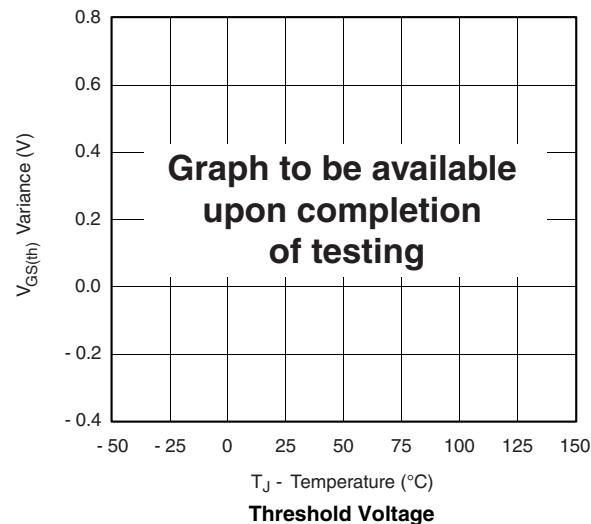
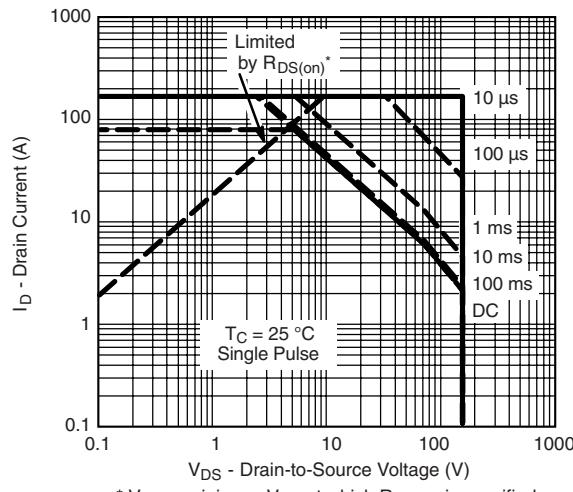
Notes

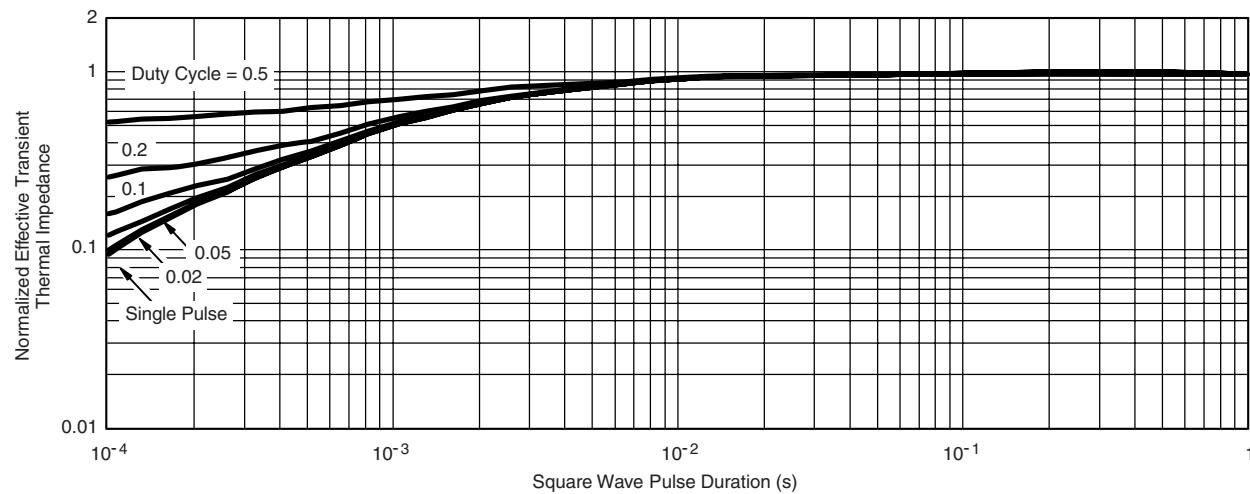
- a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

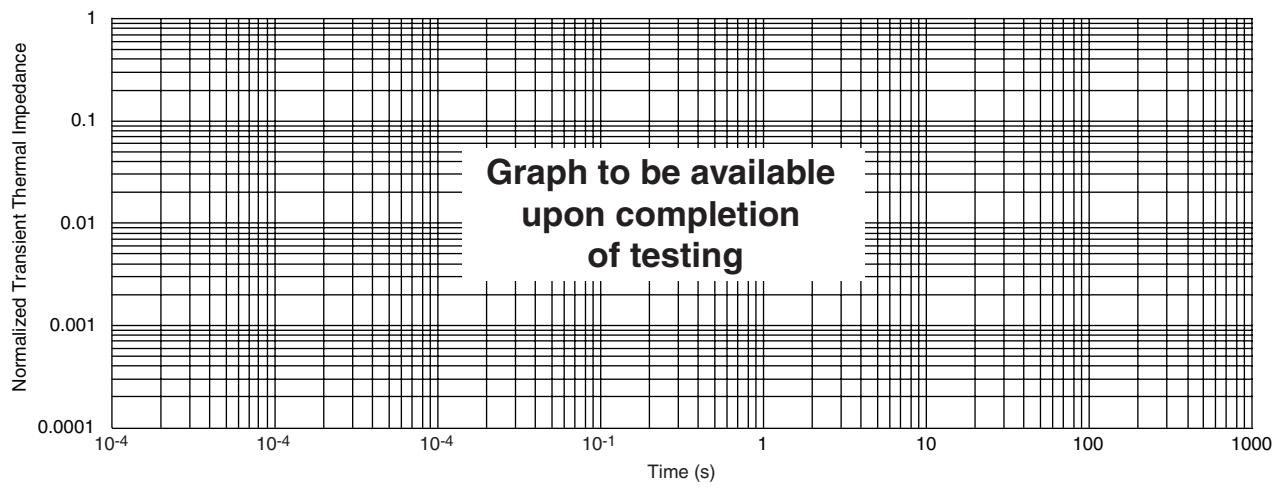
TYPICAL CHARACTERISTICS $T_A = 25^\circ\text{C}$, unless otherwise noted


TYPICAL CHARACTERISTICS $T_A = 25^\circ\text{C}$, unless otherwise noted**On-Resistance vs. Junction Temperature****Source Drain Diode Forward Voltage****On-Resistance vs. Gate-to-Source Voltage****Drain Source Breakdown vs. Junction Temperature**

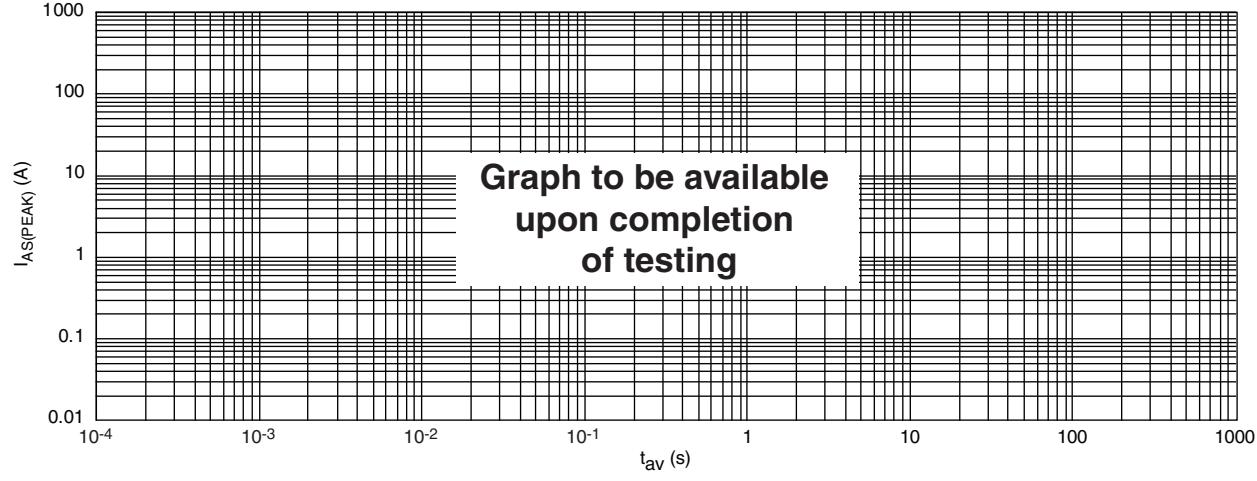
THERMAL RATINGS $T_A = 25^\circ\text{C}$, unless otherwise noted

Maximum Drain Current vs. Ambient Temperature

Avalanche Current vs. Time

Single Pulse Power, Junction-to-Ambient

**Graph to be available
upon completion
of testing**

Safe Operating Area

THERMAL RATINGS $T_A = 25^\circ\text{C}$, unless otherwise noted


Normalized Thermal Transient Impedance, Junction-to-Case

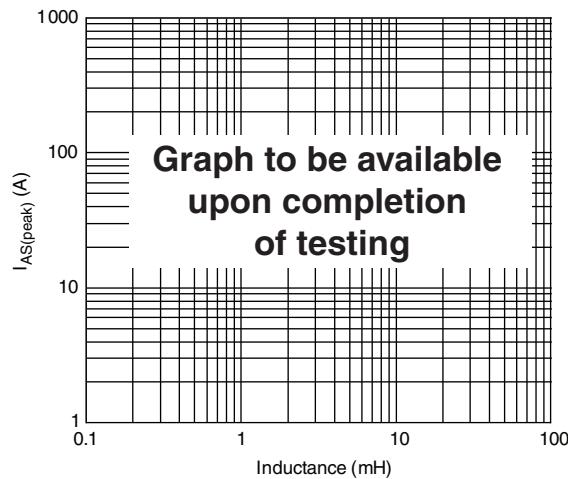


Normalized Thermal Transient Impedance, Junction-to-Ambient

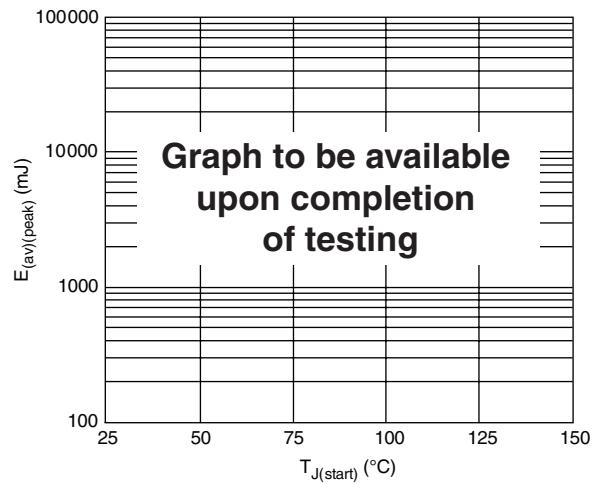


Single Pulse Avalanche Current (Peak) vs. Time in Avalanche

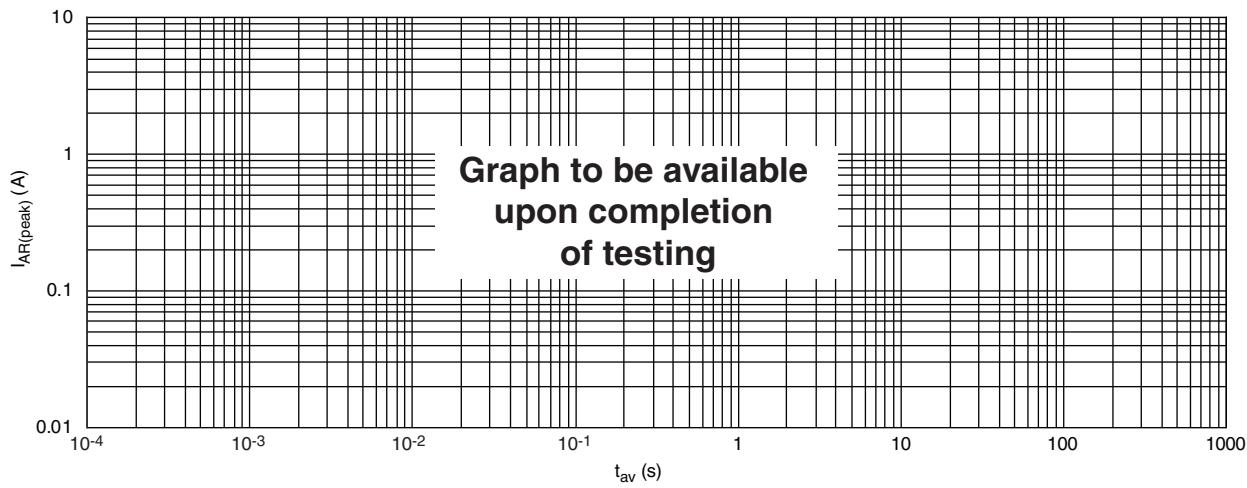
THERMAL RATINGS $T_A = 25^\circ\text{C}$, unless otherwise noted



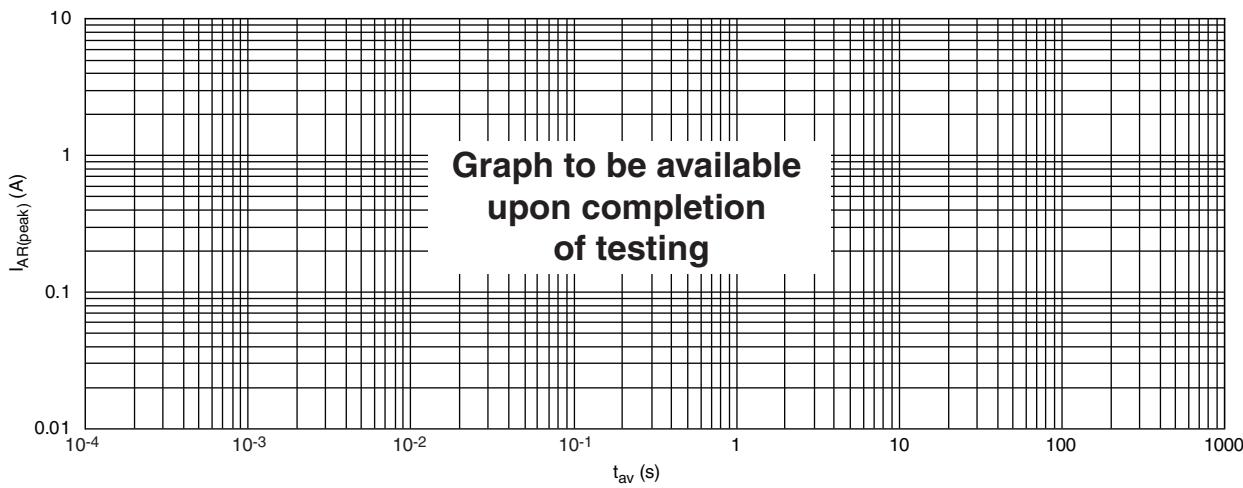
Single Pulse Avalanche Current (Peak) vs. Inductance



Single Pulse Avalanche Energy (Peak) vs. $T_{J(\text{start})}$



Repetitive Avalanche Current (Peak) vs. Time in Avalanche at $T_A = 25^\circ\text{C}$

THERMAL RATINGS $T_A = 25^\circ\text{C}$, unless otherwise noted**Repetitive Avalanche Current (Peak) vs. Time in Avalanche at $T_A = 150^\circ\text{C}$** **Note**

The characteristics shown in the six graphs

- Normalized Transient Thermal Impedance Junction to Ambient (25°C)
- Single Pulse Avalanche Current (Peak) vs. Time in Avalanche
- Single Pulse Avalanche Current (Peak) vs. Inductance
- Single Pulse Avalanche Energy (Peak) vs. T_J (start)
- Repetitive Avalanche Current (Peak) vs. Time in Avalanche at $T_A = 25^\circ\text{C}$
- Repetitive Avalanche Current (Peak) vs. Time in Avalanche at $T_A = 150^\circ\text{C}$

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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